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# **MC9S12DJ64**

## **Device User Guide**

### **V01.20**

**Covers also**

**MC9S12D64, MC9S12A64, MC9S12D32,  
MC9S12A32**

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# Revision History

Version Number	Revision Date	Effective Date	Author	Description of Changes
V01.00	16 NOV 2001	19 NOV 2001		Initial version based on MC9SDP256-2.09 Version.
V01.01	18 FEB 2002	18 FEB 2002		In table 7 I/O Characteristics" of the electrical characteristics replaced tPULSE with tpign and tpval in lines "Port ... Interrupt Input Pulse filtered" and "Port ... Interrupt Input Pulse passed" respectively.
V01.02	6 MAR 2002	6 MAR 2002		Table "Oscillator Characteristics": removed "Oscillator start-up time from POR or STOP" row Table "5V I/O Characteristics": Updated Partial Drive IOH = +−2mA and Full Drive IOH = −10mA Table "ATD Operating Characteristics": Distinguish IREF for 1 and 2 ATD blocks on Table "ATD Electrical Characteristics": Update CINS to 22 pF Table "Operating Conditions": Changed VDD and VDDPLL to 2.35 V (min) Removed Document number except from Cover Sheet Updated Table "Document References"
V01.03	4 June 2002	4 June 2002		Table "5V I/O Characteristics" : Corrected Input Capacitance to 6pF Section: "Device Pinout" (112-pin and 80-pin): added in diagrams RXCAN0 to PJ6 and TXCAN0 to PJ7 Table "PLL Characteristics": Updated parameters K <sub>1</sub> and f <sub>1</sub> Figure "Basic PLL functional diagram": Inserted XFC pin in diagram Enhanced section "XFC Component Selection" Added to Sections ATD, ECT and PWM: freeze mode = active BDM mode
V01.04	4 July 2002	4 July 2002		Added 1L86D to Table "Assigned Part ID numbers" Corrected MEMSIZ1 value in Table "Memory size registers" Subsection "Device Memory Map: Removed Flash mapping from \$0000 to \$3FFF. Table "Signal Properties": Added column "Internal Pull Resistor". Preface Table "Document References": Changed to full naming for each block. Table "Interrupt Vector Locations", Column "Local Enable": Corrected several register and bit names.
V01.05	30 July 2002	30 July 2002		Figure "Recommended PCB Layout for 80QFP: Corrected VREGEN pin position Thermal values for junction to board and package BGND pin pull-up Part Order Information Global Register Table Chip Configuration Summary Modified mode of Operations chapter Section "Printed Circuit Board Layout Proposals": added Pierce Oscillator examples for 112LQFP and 80QFP

Version Number	Revision Date	Effective Date	Author	Description of Changes
V01.06	20 Aug. 2002	20 Aug. 2002		NVM electricals updated Subsection "Detailed Register Map: Address corrections Preface, Table "Document references": added OSC User Guide New section "Oscillator (OSC) Block Description"
V01.07	20 Sept. 2002	20 Sept. 2002		Electrical Characteristics: -> Section "General": removed preliminary disclaimer ->Table "Supply Current Characteristics": changed max Run IDD from 65mA to 50mA changes max Wait IDD from 40mA to 30mA changed max Stop IDD from 50uA to 100uA Section HCS12 Core Block Description: mentioned alternate clock of BDM to be equivalent to oscillator clock
V01.08	25 Sept. 2002	25 Sept. 2002		Table "5V I/O Characteristics": Corrected Input Leakage Current to +/- 1 uA Section "Part ID assignment": Located on start of next page for better readability
V01.09	10 Oct. 2002	10 Oct. 2002		Added MC9S12A64 derivative to cover sheet and "Derivative Differences" Table Corrected in footnote of Table "PLL Characteristics": $f_{OSC} = 4\text{MHz}$
V01.10	8 Nov. 2002	8 Nov. 2002		Renamed "Preface" section to "Derivative Differences and Document references". Added details for derivatives missing CAN0 and/or BDLC Table "ESD and Latch-up Test Conditions": changed pulse numbers from 3 to 1 Table "ESD and Latch-Up Protection Characteristics": changed parameter classification from C to T Table "5V I/O Characteristics": removed foot note from "Input Leakage Current" Table " Supply Current Characteristics": updated Stop and Pseudo Stop currents
V01.11	24 Jan. 2003	24 Jan. 2003		Subsection "Detailed Register Map": Corrected several entries Subsection "Unsecuring the Microcontroller": Added more details Table "Operating Conditions": improved footnote 1 wording, applied footnote 1 to PLL Supply Voltage.
V01.12	31 Mar. 2003	31 Mar. 2003		Tables "SPI Master/Slave Mode Timing Characteristics: Corrected Operating Frequency Appendix 'NVM, Flash and EEPROM': Replaced 'burst programming' by 'row programming' Table "Operating Conditions": corrected minimum bus frequency to 0.25MHz Section "Feature List": ECT features changed to "Four pulse accumulators ..."
V01.13	20 May 2003	20 May 2003		Replaced references to HCS12 Core Guide by the individual HCS12 Block guides Table "Signal Properties" corrected pull resistor reset state for PE7 and PE4-PE2. Table "Absolute Maximum Ratings" corrected footnote on clamp of TEST pin.
V01.14	10 June 2003	10 June 2003		Added cycle definition to "CPU 12 Block Description". Added register reset values to MMC and MEBI block descriptions. Diagram "Clock Connections": Connect Bus Clock to HCS12 Core

Version Number	Revision Date	Effective Date	Author	Description of Changes
V01.15	22 July 2003	22 July 2003		Mentioned "S12 LRAE" bootloader in Flash section Section Document References: corrected S12 CPU document reference
V01.16	24 Feb. 2004	24 Feb. 2004		Added 3L86D maskset with corresponding Part ID Table Oscillator Characteristics: Added more details for EXTAL pin
V01.17	21 May 2004	21 May 2004		Added 4L86D maskset with corresponding Part ID Table "MC9S12DJ64 Memory Map out of Reset": corrected \$1000 - \$3fff memory in single chip modes to "unimplemented".
V01.18	13 July 2004	13 July 2004		Added MC9S12D32 and MC9S12A32
V01.19	2 Sept. 2004	2 Sept. 2004		Appendix, Table "Oscillator Characteristics": changed item 13 VIH,EXTAL min value from $0.7 \cdot VDDPLL$ to $0.75 \cdot VDDPLL$ item 14 VIL,EXTAL max value from $0.3 \cdot VDDPLL$ to $0.25 \cdot VDDPLL$
V01.20	6 April 2005	6 April 2005		Table "Assigned Part ID Numbers": added mask set number 0M89C Table "NVM Reliability Characteristics": added footnote concerning data retention

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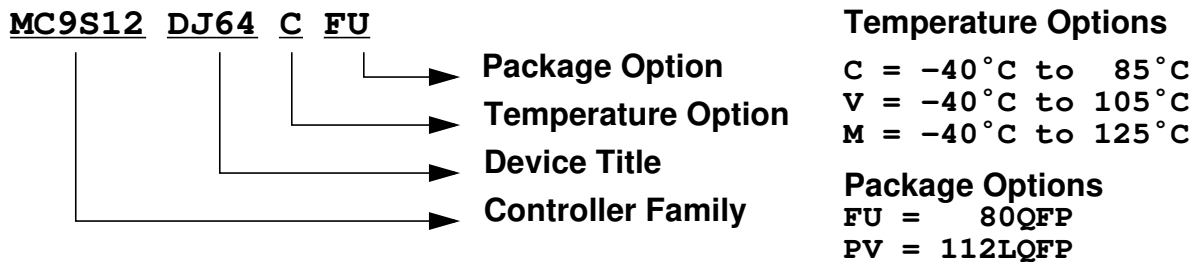
# Derivative Differences and Document References

## Derivative Differences

**Table 0-1** shows the availability of peripheral modules on the various derivatives. For details about the compatibility within the MC9S12D-Family refer also to engineering bulletin EB386.

**Table 0-1 Derivative Differences**

Generic device	MC9S12DJ64	MC9S12D64	MC9S12A64	MC9S12D32	MC9S12A32
CAN0	1	1	0	1	0
J1850/BDLC	1	0	0	0	0
Packages	112LQFP, 80QFP	112LQFP, 80QFP	112LQFP, 80QFP	80QFP	80QFP
Mask Set	L86D	L86D	L86D	L86D	L86D
Temp Options	M, V, C	M, V, C	C	M, V, C	C
Package Codes	PV, FU	PV, FU	PV, FU	FU	FU
Note	An errata exists contact Sales office	An errata exists contact Sales office	An errata exists contact Sales office	An errata exists contact Sales office	An errata exists contact Sales office



**Figure 0-1 Order Partnumber Example**

The following items should be considered when using a derivative.

- **Registers**
  - Do not write or read CAN0 registers (after reset: address range \$0140 - \$017F), if using a derivative without CAN0 (see **Table 0-1**).
  - Do not write or read BDLC registers (after reset: address range \$00E8 - \$00EF), if using a derivative without BDLC (see **Table 0-1**).
- **Interrupts**
  - Fill the four CAN0 interrupt vectors (\$FFB0 - \$FFB7) according to your coding policies for unused interrupts, if using a derivative without CAN0 (see **Table 0-1**).
  - Fill the BDLC interrupt vector (\$FFC2, \$FFC3) according to your coding policies for unused interrupts, if using a derivative without BDLC (see **Table 0-1**).

- **Ports**
  - The CAN0 pin functionality (TXCAN0, RXCAN0) is not available on port PJ7, PJ6, PM5, PM4, PM3, PM2, PM1 and PM0, if using a derivative without CAN0 (see **Table 0-1**).
  - The BDLC pin functionality (TXB, RXB) is not available on port PM1 and PM0, if using a derivative without BDLC (see **Table 0-1**).
  - Do not write MODRR1 and MODRR0 Bit of Module Routing Register (PIM\_9DJ64 Block User Guide), if using a derivative without CAN0 (see **Table 0-1**).
- **Pins not available in 80 pin QFP package**
  - **Port H**  
In order to avoid floating nodes the ports should be either configured as outputs by setting the data direction register (DDRH at Base+\$0262) to \$FF, or enabling the pull resistors by writing a \$FF to the pull enable register (PERH at Base+\$0264).
  - **Port J[1:0]**  
Port J pull-up resistors are enabled out of reset on all four pins (7:6 and 1:0). Therefore care must be taken not to disable the pull enables on PJ[1:0] by clearing the bits PERJ1 and PERJ0 at Base+\$026C.
  - **Port K**  
Port K pull-up resistors are enabled out of reset, i.e. Bit 7 = PUKE = 1 in the register PUCR at Base+\$000C. Therefore care must be taken not to clear this bit.
  - **Port M[7:6]**  
PM7:6 must be configured as outputs or their pull resistors must be enabled to avoid floating inputs.
  - **Port P6**  
PP6 must be configured as output or its pull resistor must be enabled to avoid a floating input.
  - **Port S[7:4]**  
PS7:4 must be configured as outputs or their pull resistors must be enabled to avoid floating inputs.
  - **PAD[15:8] (ATD1 channels)**  
Out of reset the ATD1 is disabled preventing current flows in the pins. Do not modify the ATD1 registers!

## Document References

The Device User Guide provides information about the MC9S12DJ64 device made up of standard HCS12 blocks and the HCS12 processor core.

This document is part of the customer documentation. A complete set of device manuals also includes all the individual Block Guides of the implemented modules. In an effort to reduce redundancy all module specific information is located only in the respective Block Guide. If applicable, special implementation details of the module are given in the block description sections of this document.

See **Table 0-2** for names and versions of the referenced documents throughout the Device User Guide.

**Table 0-2 Document References**

User Guide	Version	Document Order Number
HCS12 CPU Reference Manual	V02	S12CPUV2/D
HCS12 Module Mapping Control (MMC) Block Guide	V04	S12MMCV4/D
HCS12 Multiplexed External Bus Interface (MEBI) Block Guide	V03	S12MEBIV3/D
HCS12 Interrupt (INT) Block Guide	V01	S12INTV1/D
HCS12 Background Debug (BDM) Block Guide	V04	S12BDMV4/D
HCS12 Breakpoint (BKP) Block Guide	V01	S12BKPV1/D
Clock and Reset Generator (CRG) Block User Guide	V04	S12CRGV4/D
Oscillator (OSC) Block User Guide	V02	S12OSCV2/D
Enhanced Capture Timer 16 Bit 8 Channel (ECT_16B8C) Block User Guide	V01	S12ECT16B8CV1/D
Analog to Digital Converter 10 Bit 8 Channel (ATD_10B8C) Block User Guide	V02	S12ATD10B8CV2/D
Inter IC Bus (IIC) Block User Guide	V02	S12IICV2/D
Asynchronous Serial Interface (SCI) Block User Guide	V02	S12SCIV2/D
Serial Peripheral Interface (SPI) Block User Guide	V02	S12SPIV2/D
Pulse Width Modulator 8 Bit 8 Channel (PWM_8B8C) Block User Guide	V01	S12PWM8B8CV1/D
64K Byte Flash (FTS64K) Block User Guide	V01	S12FTS64KV1/D
1K Byte EEPROM (EETS1K) Block User Guide	V01	S12EETS1KV1/D
Byte Level Data Link Controller -J1850 (BDLC) Block User Guide	V01	S12BDLCV1/D
Freescale Scalable CAN (MSCAN) Block User Guide	V02	S12MSCANV2/D
Voltage Regulator (VREG) Block User Guide	V01	S12VREGV1/D
Port Integration Module (PIM_9DJ64) Block User Guide	V01	S12PIM9DJ64V1/D



# Section 1 Introduction

## 1.1 Overview

The MC9S12DJ64 microcontroller unit (MCU) is a 16-bit device composed of standard on-chip peripherals including a 16-bit central processing unit (HCS12 CPU), 64K bytes of Flash EEPROM, 4K bytes of RAM, 1K bytes of EEPROM, two asynchronous serial communications interfaces (SCI), one serial peripheral interfaces (SPI), an 8-channel IC/OC enhanced capture timer, two 8-channel, 10-bit analog-to-digital converters (ADC), an 8-channel pulse-width modulator (PWM), a digital Byte Data Link Controller (BDLC), 29 discrete digital I/O channels (Port A, Port B, Port K and Port E), 20 discrete digital I/O lines with interrupt and wakeup capability, a CAN 2.0 A, B software compatible modules (MSCAN12), and an Inter-IC Bus. The MC9S12DJ64 has full 16-bit data paths throughout. However, the external bus can operate in an 8-bit narrow mode so single 8-bit wide memory can be interfaced for lower cost systems. The inclusion of a PLL circuit allows power consumption and performance to be adjusted to suit operational requirements.

## 1.2 Features

- HCS12 Core
  - 16-bit HCS12 CPU
    - i. Upward compatible with M68HC11 instruction set
    - ii. Interrupt stacking and programmer's model identical to M68HC11
    - iii. Instruction queue
    - iv. Enhanced indexed addressing
  - MEBI (Multiplexed External Bus Interface)
  - MMC (Module Mapping Control)
  - INT (Interrupt control)
  - BKP (Breakpoints)
  - BDM (Background Debug Mode)
- CRG (low current Colpitts or Pierce oscillator, PLL, reset, clocks, COP watchdog, real time interrupt, clock monitor)
- 8-bit and 4-bit ports with interrupt functionality
  - Digital filtering
  - Programmable rising or falling edge trigger
- Memory
  - 64K Flash EEPROM
  - 1K byte EEPROM

- 4K byte RAM
- Two 8-channel Analog-to-Digital Converters
  - 10-bit resolution
  - External conversion trigger capability
- 1M bit per second, CAN 2.0 A, B software compatible module
  - Five receive and three transmit buffers
  - Flexible identifier filter programmable as 2 x 32 bit, 4 x 16 bit or 8 x 8 bit
  - Four separate interrupt channels for Rx, Tx, error and wake-up
  - Low-pass filter wake-up function
  - Loop-back for self test operation
- Enhanced Capture Timer
  - 16-bit main counter with 7-bit prescaler
  - 8 programmable input capture or output compare channels
  - Four 8-bit or two 16-bit pulse accumulators
- 8 PWM channels
  - Programmable period and duty cycle
  - 8-bit 8-channel or 16-bit 4-channel
  - Separate control for each pulse width and duty cycle
  - Center-aligned or left-aligned outputs
  - Programmable clock select logic with a wide range of frequencies
  - Fast emergency shutdown input
  - Usable as interrupt inputs
- Serial interfaces
  - Two asynchronous Serial Communications Interfaces (SCI)
  - Synchronous Serial Peripheral Interface (SPI)
- Byte Data Link Controller (BDLC)
  - SAE J1850 Class B Data Communications Network Interface Compatible and ISO Compatible for Low-Speed (<125 Kbps) Serial Data Communications in Automotive Applications
- Inter-IC Bus (IIC)
  - Compatible with I2C Bus standard
  - Multi-master operation
  - Software programmable for one of 256 different serial clock frequencies
- 112-Pin LQFP or 80 QFP package

- I/O lines with 5V input and drive capability
- 5V A/D converter inputs
- Operation at 50MHz equivalent to 25MHz Bus Speed
- Development support
- Single-wire background debug™ mode (BDM)
- On-chip hardware breakpoints

## 1.3 Modes of Operation

### User modes

- Normal and Emulation Operating Modes
  - Normal Single-Chip Mode
  - Normal Expanded Wide Mode
  - Normal Expanded Narrow Mode
  - Emulation Expanded Wide Mode
  - Emulation Expanded Narrow Mode
- Special Operating Modes
  - Special Single-Chip Mode with active Background Debug Mode
  - Special Test Mode (Freescale **use only**)
  - Special Peripheral Mode (Freescale **use only**)

### Low power modes

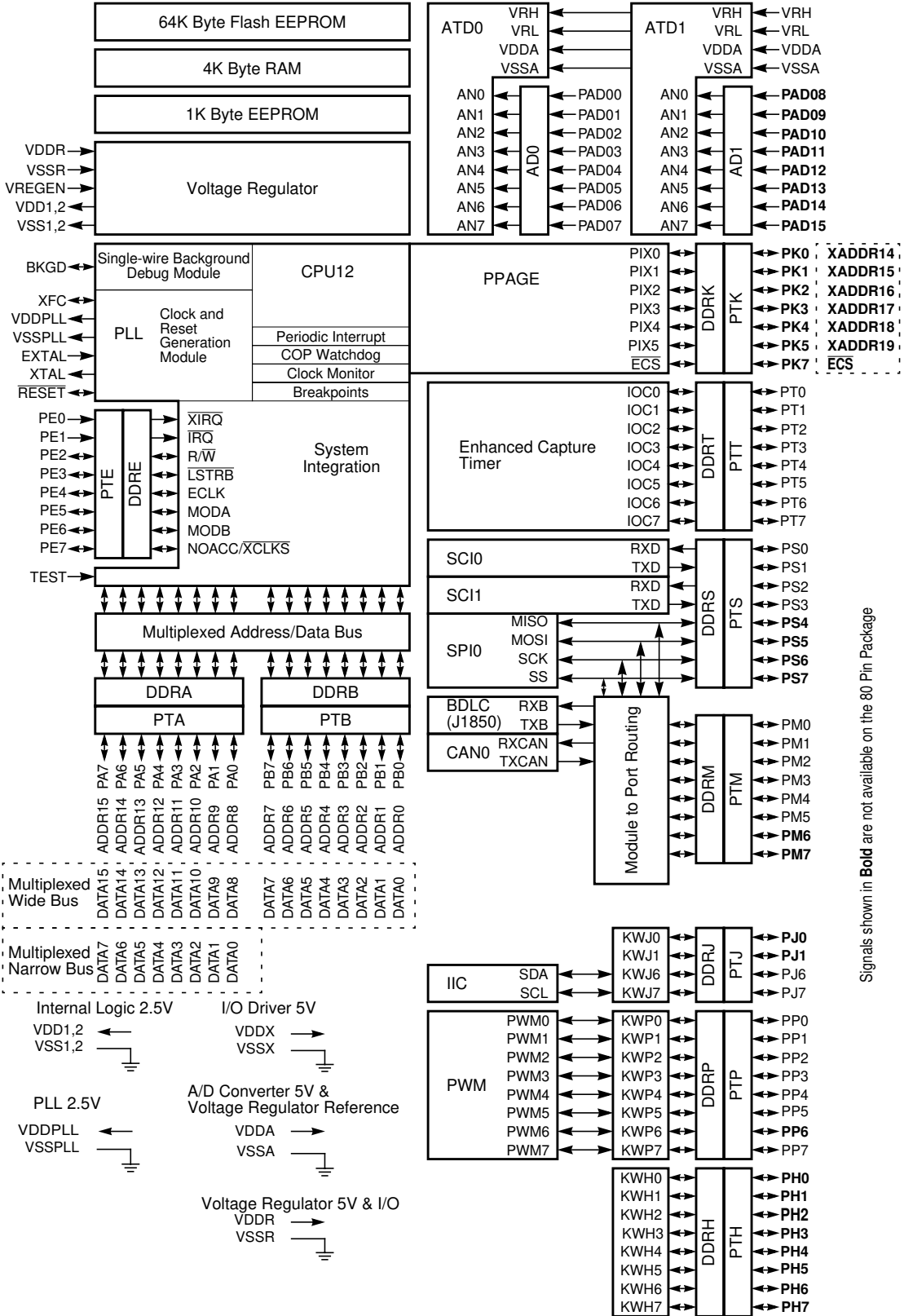
- Stop Mode
- Pseudo Stop Mode
- Wait Mode



## 1.4 Block Diagram

**Figure 1-1** shows a block diagram of the MC9S12DJ64 device.

Figure 1-1 MC9S12DJ64 Block Diagram





## 1.5 Device Memory Map

**Table 1-1** and **Figure 1-2** show the device memory map of the MC9S12DJ64 after reset. The 1K EEPROM is mapped twice in a 2K address space. Note that after reset the bottom 1k of the EEPROM (\$0000 - \$03FF) are hidden by the register space, and the 1K \$0400 - \$07FF is hidden by the RAM.

**Table 1-1 Device Memory Map for MC9S12DJ64**

Address	Module	Size (Bytes)
\$0000 - \$000F	HCS12 Multiplexed External Bus Interface	16
\$0010 - \$0014	HCS12 Module Mapping Control	5
\$0015 - \$0016	HCS12 Interrupt	2
\$0017 - \$0019	Reserved	3
\$001A - \$001B	Device ID register (PARTID)	2
\$001C - \$001D	HCS12 Module Mapping Control	2
\$001E	HCS12 Multiplexed External Bus Interface	1
\$001F	HCS12 Interrupt	1
\$0020 - \$0027	Reserved	8
\$0028 - \$002F	HCS12 Breakpoint Module	8
\$0030 - \$0031	HCS12 Module Mapping Control	2
\$0032 - \$0033	HCS12 Multiplexed External Bus Interface	2
\$0034 - \$003F	Clock and Reset Generator (PLL, RTI, COP)	12
\$0040 - \$007F	Enhanced Capture Timer 16-bit 8 channels	64
\$0080 - \$009F	Analog to Digital Converter 10-bit 8 channels (ATD0)	32
\$00A0 - \$00C7	Pulse Width Modulator 8-bit 8 channels (PWM)	40
\$00C8 - \$00CF	Serial Communications Interface 0 (SCI0)	8
\$00D0 - \$00D7	Serial Communications Interface 0 (SCI1)	8
\$00D8 - \$00DF	Serial Peripheral Interface (SPI0)	8
\$00E0 - \$00E7	Inter IC Bus	8
\$00E8 - \$00EF	Byte Data Link Controller (BDLC)	8
\$00F0 - \$00FF	Reserved	16
\$0100- \$010F	Flash Control Register	16
\$0110 - \$011B	EEPROM Control Register	12
\$011C - \$011F	Reserved	4
\$0120 - \$013F	Analog to Digital Converter 10-bit 8 channels (ATD1)	32
\$0140 - \$017F	Freescale Scalable Can (CAN0)	64
\$0180 - \$023F	Reserved	192
\$0240 - \$027F	Port Integration Module (PIM)	64
\$0280 - \$03FF	Reserved	384
\$0000 - \$07FF	EEPROM array 1k Array mapped twice in the address space	2048
\$0000 - \$0FFF	RAM array	4096
\$4000 - \$7FFF	Fixed Flash EEPROM array incl. 0.5K, 1K, 2K or 4K Protected Sector at start	16384
\$8000 - \$BFFF	Flash EEPROM Page Window	16384